

Radial Heat Sink

This high-performance radial heat sink is designed for efficient heat dissipation. It features a dense array of aluminum fins arranged in a circular pattern to maximize surface area for optimal thermal transfer.



Product Overview

High-Performance Thermal Management

This radial heat sink is engineered for superior heat dissipation in demanding electronic environments. Featuring a dense array of aluminum fins in a circular configuration, it maximizes surface area to ensure optimal thermal transfer for critical components. Its lightweight construction provides both excellent conductivity and corrosion resistance, making it an ideal solution for cooling CPUs, GPUs, and other high-heat devices.

Technical Specifications

Material	Aluminum
Design Type	Radial Fin Array
Key Features	Lightweight, Corrosion Resistant, High Surface Area, Thermal Conductivity

Applications

Suitable Applications

- CPU Cooling
- GPU Cooling
- Electronic Component Thermal Management